OVLLx8C7



Features:

- Wide viewing angle
- High-brightness indicator
- Industry standard lead spacing
- Unique lens shape for flexible applications



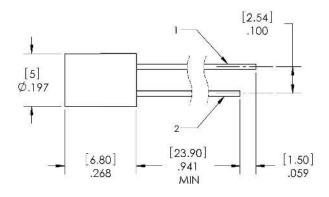
Description:

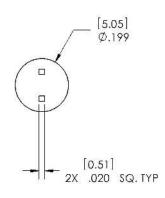
The OVLLx8C7 series is designed for superior performance in signage and lighting applications that require wide-angle uniform light output. These devices combine a high-intensity LED with a unique flat-topped T-1¾ package to provide both high brightness and a wide spatial radiation pattern.

Applications:

- Channel letter and other signage backlighting
- Decorative architectural indoor and outdoor lighting accents
- Industrial and consumer indicators

Part Number	Material	Emitted Color	Intensity Typ. mcd	Lens Color
OVLLB8C7	InGaN	Blue	440	Clear
OVLLG8C7	InGaN	Green	2400	Clear
OVLLR8C7	AllnGaP	Red	900	Clear
OVLLY8C7	AllnGaP	Yellow	980	Clear





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DIMENSIONS ARE IN INCHES AND [MILLIMETERS].

TOLERANCES ARE .005 [.12] UNLESS OTHERWISE SPECIFIED.





DO NOT LOOK DIRECTLY AT LED
WITH UNSHIELDED EYES OR
DAMAGE TO RETINA MAY
OCCUR.





Electrical Specifications

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

Storage Temperature Range		-40 ~ +100° C
Operating Temperature Range		-40 ~ +100° C
Reverse Voltage		5 V
Continuous Forward Current	Blue, Green	25 mA
Continuous Forward Current	Red, Yellow	50 mA
Peak Forward Current (10% Duty Cycle, 1 KHz)		100 mA
Power Dissipation	Blue, Green	100 mW
Power Dissipation	Red, Yellow	120 mW
Lead Soldering Temperature (4 mm from the base of the epoxy bulb) ¹		260° C / 5 seconds
LED Junction Temperature		125° C
Electrostatic Discharge Classification (JEDEC-JESD22-A114F)		Class 1C
Current Linearity vs. Ambient Temperature	Blue, Green	-0.29 mA/° C
Current Linearity vs. Ambient Temperature	Red, Yellow	-0.72 mA/° C

Electrical Characteristics T_A = 25° C unless otherwise noted

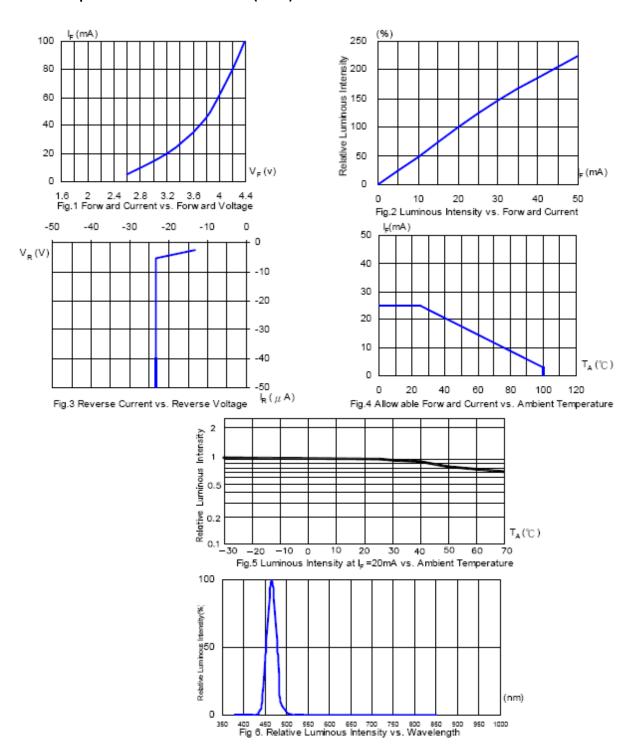
SYMBOL	PARAMETER	COLOR	MIN	TYP	MAX	UNITS	CONDITIONS	
I _v		Blue	295	440				
	Luminous Intensitu	Green	1135	2400		mcd	I _F = 20 mA	
	Luminous Intensity	Red	580	900				
		Yellow	580	980				
V _F	Forward Voltage	Blue, Green		3.2	4.0	V	1 20 m A	
	Forward Voltage	Red, Yellow		2.0	2.4		I _F = 20 mA	
I _R	Daviere Comment	Blue, Green			10	4	V 5V	
	Reverse Current	Red, Yellow		10	μΑ	$V_R = 5 V$		
λ _D Doi		Blue	460	470	475	nm	I _F = 20 mA	
	Dominant Wayalangth	Green	519	525	531			
	Dominant Wavelength	Red	620	623	630			
		Yellow	585	589	595			
20½н-н	FOO/ Power Angle	Blue, Green		85		dog	20 4	
	50% Power Angle	Red, Yellow		100		deg	I _F = 20 mA	

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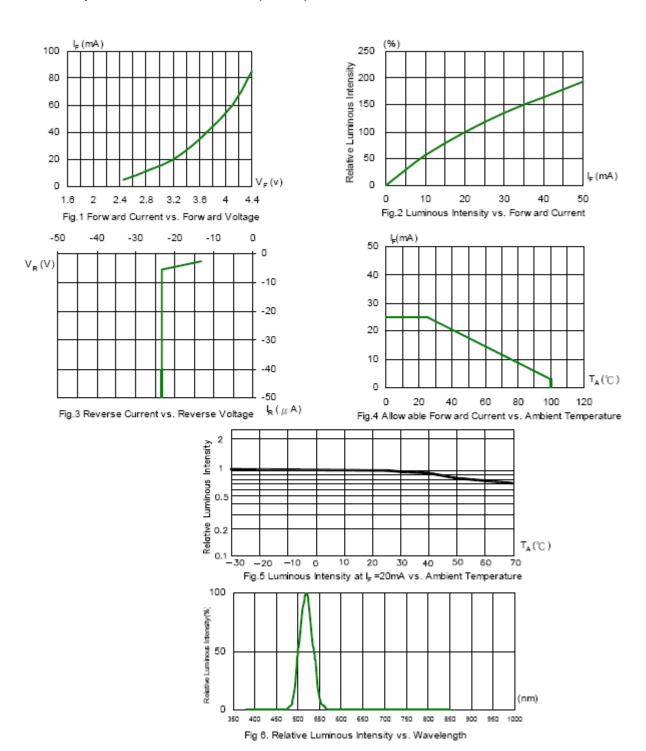
Typical Electro-Optical Characteristics Curves (BLUE)



OVLLx8C7



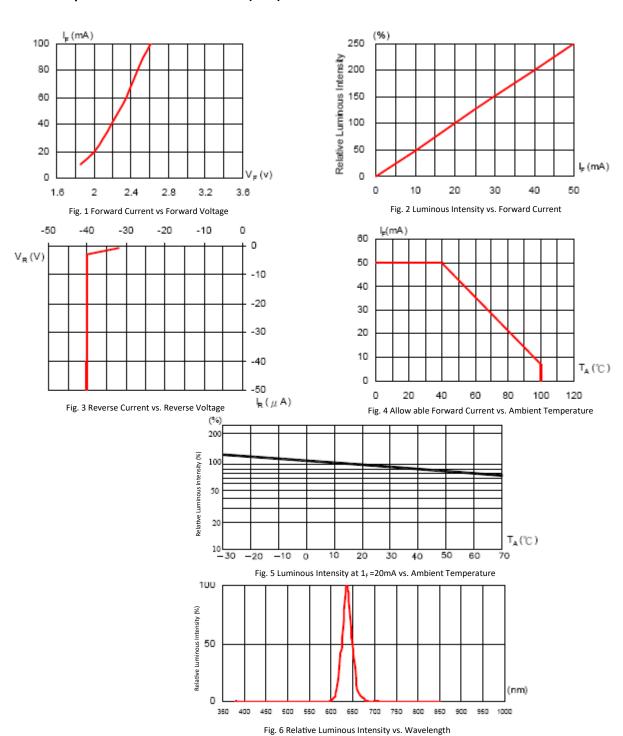
Typical Electro-Optical Characteristics Curves (GREEN)



OVLLx8C7



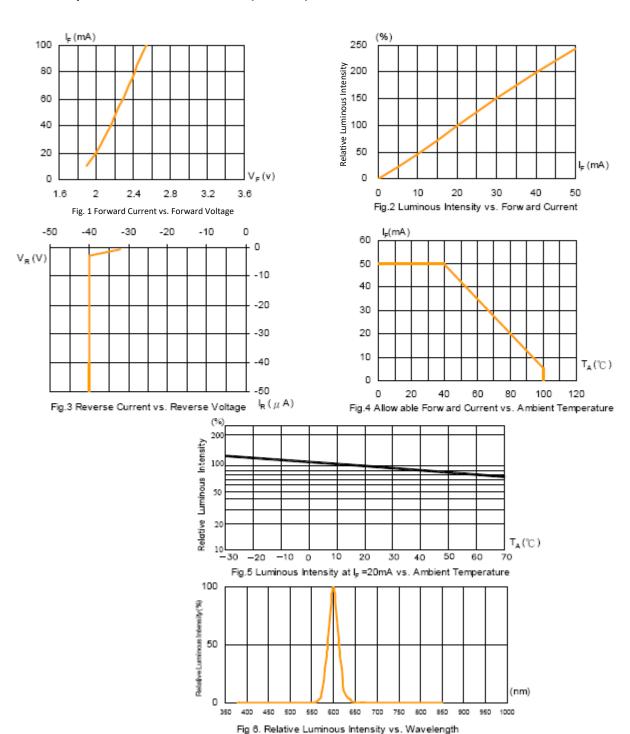
Typical Electro-Optical Characteristics Curves (RED)



OVLLx8C7



Typical Electro-Optical Characteristics Curves (YELLOW)

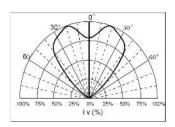


OVLLx8C7

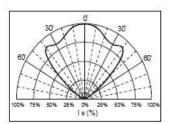


Beam Pattern

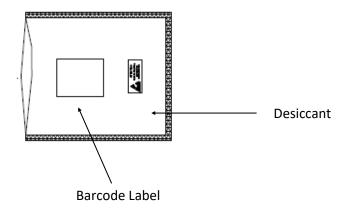
BLUE and GREEN



RED and YELLOW



Packaging: 500 pcs per bulk bag with desiccant



OVLLx8C7



Reliability Test

LED lamps are checked by reliability tests based on MIL standards.

1. Test Conditions, Acceptable Criteria & Results:

Classi- fication	Test Item	Standard Test Method	Test Conditions	Duration	Unit	Acc / Rej Criteria	Result
Life Test	Operation Life Test (OLT)	MIL-STD-750D Method 1026.3	T _A =25°C , I _F =30mA *	1000 Hrs	100	0/1	Pass
Environment Test	High Temperature Storage (HTS)	MIL-STD-750D Method 1032.1	T _A =100°C	1000 Hrs	100	0 / 1	Pass
	Low Temperature Storage (LTS)	MIL-STD-750D Method 1032.1	T _A =-40°C	1000 Hrs	100	0 / 1	Pass
	Temp. & Humidity with Bias (THB)	MIL-STD-750D Method 103B	T _A =85°C , Rh=85% I _F =20mA **	500 Hrs	100	0 / 1	Pass
	Thermal Shock Test (TST)	MIL-STD-750D Method 1056.1	0°C ~ 100°C 2min 2min	100 cycles	100	0/1	Pass
	Temperature Cycling Test (TCT)	MIL-STD-750D Method 1051.5	-40°C ~ 25°C ~ 100°C ~ 25°C 30min 5min 30min 5min	100 cycles	100	0 / 1	Pass
Mechanical Test	Solderability	MIL-STD-750D Method 2026.4	235±5°C → 5 sec.	1 time	20	0/1	Pass
	Resistance to Soldering Heat	MIL-STD-750D Method 2031.1	260±5°C → 5 sec.	1 time	20	0 / 1	Pass
	Lead Integrity	MIL-STD-750D Method 2036.3	Load 2.5N (0.25kgf) 0°~90°~0°, bend	3 times	20	0 / 1	Pass

Remark: (*) IF = 30mA for AlInGaP chip; IF = 20mA for InGaN chip

(**) IF =20mA for AlInGaP chip; IF =10mA for InGaN chip

2. Failure Criteria (T_A =25°C):

Test Item	Symbol	Test Conditions	Criteria for Judgment		
	- Cymbol	rest conditions	Min.	Max.	
Luminous Intensity	I_{V}	I _F =20 mA	LSL×0.7 **		
Forward Voltage	$V_{\mathbf{F}}$	I _F =20 mA		USL×1.1 *	

(*) USL: Upper Standard Level , (**) LSL: Lower Standard Level